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Form PTO-1449 (Modified)		ATTY DOCKET NO. B-3964 618029-8	U.S. SERIAL NO. 09/768,904
LIST OF PATENTS AND PUBLICATIONS STATEMENT		APPLICANT(S) Lap-Wai CHOW, et al.	
		FILING DATE January 24, 2001	GROUP 2815

U.S. PATENT DOCUMENTS

EXAMINER INITIAL	DOCUMENT NUMBER	ISSUE DATE	NAME	CLASS	SUBCLASS	FILING DATE or 102(e) DATE IF APPROPRIATE
JN	3,673,471	6/72	Klein et al.	317	235 R	
	3,946,426	3/76	Sanders	357	71	
	4,017,888	4/77	Christie et al.	357	54	
	4,139,864	2/79	Schulman	358	188	
	4,164,461	8/79	Schilling	204	192 EC	
	4,196,443	4/80	Dingwall	357	68	
	4,267,578	5/81	Vetter	364	709	
	4,291,391	9/81	Chatterjee et al.	365	184	
	4,295,897	10/81	Tubbs et al.	148	1.5	
	4,314,268	2/82	Yoshioka et al.	357	48	
	4,317,273	3/82	Guterman et al.	29	571	
	4,374,454	2/83	Jochems	29	571	
	4,409,434	10/83	Basset et al.	380	265	
	4,435,895	3/84	Parillo	29	571	
	4,471,376	9/84	Morcom et al.	357	71	
	4,581,628	4/86	Miyauchi et al.	357	71	
	4,583,011	4/86	Pechar	307	440	
	4,603,381	7/86	Guttag et al.	364	200	
	4,623,255	11/86	Suszko	356	389	
	4,727,493	2/88	Taylor, Sr.	364	490	



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	4,766,516	8/88	Ozdemir et al.	361	380	
	4,799,096	1/89	Koeppe	357	42	
	4,821,085	4/89	Haken et al.	357	67	
	4,830,974	5/89	Chang et al.	437	34	
	4,939,567	7/90	Kenney	257	383	
	4,975,756	12/90	Haken et al.	357	4.1	
	4,998,151	3/91	Korman et al.	257	328	
	4,962,484	10/90	Takeshima et al.	365	226	
	5,030,796	7/91	Swanson et al.	174	52.2	
	5,050,123	9/91	Castro	365	53	
	5,061,978	10/91	Mizutani et al.	357	30	
	5,065,208	11/91	Shah et al.	357	34	
	5,068,697	11/91	Noda et al.	357	23.5	
	5,070,378	12/91	Yamagata	357	23.5	
	5,101,121	3/92	Sourgen	307	465	
	5,117,276	5/92	Thomas et al.	357	71	
	5,121,089	6/92	Larson et al.	333	107	
	5,121,186	6/92	Wong et al.	257	384	
	5,132,571	7/92	McCollum et al.	307	465.1	
	5,138,197	8/92	Kuwana	307	449	
	5,146,117	9/92	Larson	307	465	
	5,168,340	12/92	Nishimura	357	376	
	5,202,591	4/93	Walden	307	450	
	5,227,649	7/93	Chapman	257	204	
	5,231,299	7/93	Ning et al.	257	316	
	5,302,539	4/94	Haken et al.	437	41	
	5,308,682	5/94	Morikawa	428	195	
	5,309,015	5/94	Kuwata et al.	257	659	
	5,336,624	8/94	Walden	437	34	
	5,341,013	8/94	Koyanagi et al.	257	368	



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	5,354,704	10/94	Yang et al.	437	52	
	5,369,299	11/94	Byrne et al.	257	638	
	5,371,390	12/94	Mohsen	257	209	
	5,376,577	12/94	Roberts et al.	437	52	
	5,384,472	1/95	Yin	257	204	
	5,399,441	3/95	Bearinger et al.	428	689	
	5,441,902	8/95	Hsieh et al.	437	34	
	5,468,990	11/95	Daum	257	632	
	5,475,251	12/95	Kuo et al.	257	316	
	5,506,806	4/96	Fukushima	365	195	
	5,531,018	7/96	Saia et al.	29	622	
	5,539,224	7/96	Ema	257	211	
	5,541,614	7/96	Lam et al.	343	792.5	
	5,571,735	11/96	Mogami et al.	437	41	
	5,576,988	11/96	Kuo et al.	365	185.04	
	5,611,940	3/97	Zettler	73	514.16	
	5,638,946	6/97	Zavracky	200	181	
	5,719,422	2/98	Burr et al.	257	336	
	5,719,430	2/98	Goto	257	403	
	5,721,150	2/98	Pasch	437	46	
	5,838,047	3/99	Yamauchi et al.	257	372	
	5,880,503	3/99	Matsumoto et al.	257	372	
	5,920,097	7/99	Horne	257	368	
	5,973,375	10/99	Baukus et al.	257	399	
	6,046,659	4/00	Loo et al.	333	262	
	6,054,659	4/00	Lee et al.	200	181	
	6,057,520	5/00	Goodwin-Johansson	200	181	
	6,117,762	9/00	Baukus et al.	438	618	
	6,154,388	11/00	Oh	365	185.04	
	6,215,158 B1	4/01	Choi	257	368	



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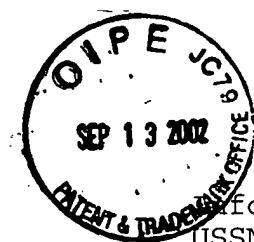
1	6,294,816 B1	9/01	Baukus et al.	257	368	
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FOREIGN PATENT DOCUMENTS

	DOCUMENT NUMBER	PUBLICATION DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION YES/NO
	98/21734	5/98	WO			
	00/44012	7/00	WO			
	0 364 769	4/90	EP			
	0 463 373	1/92	EP			
	0 528 302 A1	2/93	EP			
	0 585 601 A1	3/94	EP			
	0 764 985 A2	3/97	EP			
	0 883 184 A2	12/98	EP			
	2486717	1/82	FR			
	58-190064	11/83	JP			
	63 129647 A	6/88	JP			
	02-046762	2/90	JP			
	02-237038	9/90	JP			

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

	Document No. 02237038, dated December 6, 1990, Patent Abstracts of Japan, Vol. 014, No. 550 (E-1009).
	Document No. 63129647, dated Jun. 2, 1988, Patent Abstracts of Japan, Vol. 012, No. 385 (E-668), Oct. 14, 1998.
	Patent Abstracts of Japan, vol. 016, No. 197 (p-1350) May 12, 1992 & JP-A-40 28 092 (Toshiba Corp), abstract.
	Fredericksen, T.M., "A Multiple-Layer-Metal CMOS Process," <i>Intuitive CMOS Electronics</i> , Revised Edition, Section 5.6, pp. 134-146 (1989).
	Hodges and Jackson, <i>Analysis and Design of Digital Integrated Circuits</i> , 2nd edition, McGraw-Hill, p. 353 (1988).
	Larson, L.E., et al., "Microactuators for GaAs-based Microwave Integrated Circuits," <i>IEEE</i> , pp. 743-746 (1991).



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	Lee, "Engineering a Device for Electron-beam Probing," <i>IEEE Design and Test of Computers</i> , pp. 36-49 (1989).
	Sze, S.M., ed. <i>VLSI Technology</i> , McGraw-Hill, pp. 99, 447, and 461-465 (1983).
	Sze, S.M., ed., "Silicides for Gates and Interconnections," <i>VLSI Technology</i> , McGraw-Hill, pp. 372-380 (1983).

EXAMINER	DATE CONSIDERED
JOSEPH NGUYEN	10/31/02

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